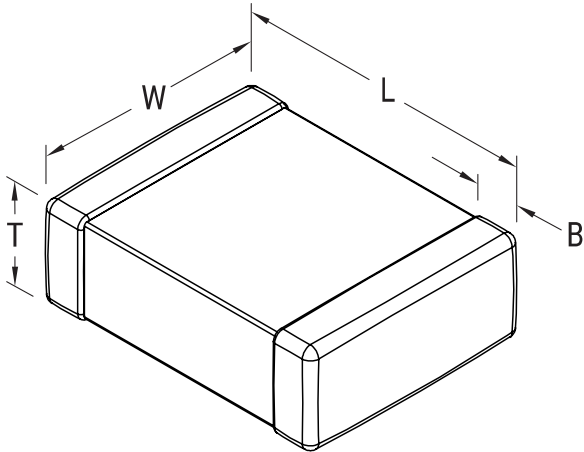




Click [here](#) for the 3D model.

General Information	
Series	GR900 SMD Space BX
Style	SMD Chip
RoHS	Yes
Termination	Tin
Failure Rate	N/A
Testing and Reliability	GR900 CSAM A
AEC-Q200	No
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0805
L	2.03mm +/-0.38mm
W	1.27mm +/-0.38mm
T	1.4mm MAX
B	0.51mm +/-0.25mm

Packaging Specifications	
Packaging	Bulk, Bag

Specifications	
Capacitance	4,700 pF
Tolerance	10%
Voltage DC	100 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	BX

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